TFA9815

Stereo full-bridge audio amplifier 2 x 17 W

Rev. 01 — 16 December 2008

Preliminary data sheet

1. General description

The TFA9815 is a 2-channel power comparator for high-efficiency class D audio amplifier systems. It contains two full-bridge Bridge-Tied Load (BTL) power stages, drive logic, protection control logic and full differential input comparators. By using this power comparator a compact closed-loop self-oscillating digital audio amplifier system or open-loop system can be built. The continuous output power is 2 ×17 W in a full-bridge BTL application. The TFA9815 does not require a heat sink and operates using an asymmetrical supply voltage.

2. Features

- Stereo full-bridge audio amplifier for class D applications
- No external heat sink required
- Operating voltage range: asymmetrical from 8 V to 20 V
- Thermally protected
- Zero dead-time switching
- Current-limiting (no audible interruptions)

3. Applications

- Self-oscillating or open-loop class D audio amplifier applications
- Flat-panel television sets
- Flat-panel monitors
- Multimedia systems
- Wireless speakers
- High-end CRT television sets

4. Quick reference data

Table 1. Quick reference data

 $V_P = 12 \ V$; $f_{osc} = 550 \ kHz$; $T_{amb} = 25 \ ^{\circ}C$; typical application diagram <u>Figure 12</u>, unless otherwise specified.

•						
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
General						
V_P	supply voltage	single, asymmetrical supply (V _{DD} - V _{SS})	8	12	20	V
I _P	supply current	Sleep mode	-	110	200	μΑ



Audio amplifier 2 x 17 W

Table 1. Quick reference data ...continued

 V_P = 12 V; f_{osc} = 550 kHz; T_{amb} = 25 °C; typical application diagram <u>Figure 12</u>, unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$I_{q(tot)}$	total quiescent current	Operating mode; no load; no snubbers; no filter connected	-	40	50	mA
η_{po}	output power efficiency	output power; 2×10 W into 8 Ω	89	91	-	%
P _{o(RMS)}	RMS output power	V_P = 15 V; R_L = 8 Ω ; THD = 10 %	15	16	-	W
		V_P = 12 V; R_L = 8 Ω ; THD = 10 %	9	10	-	W
		V_P = 12 V; R_L = 6 Ω ; THD = 10 %	12	13	-	W
		$\begin{split} V_P &= 12 \text{ V}; \text{ R}_L = 4 \Omega; \\ \text{THD} &= 10 \% \end{split}$	17	18	-	W

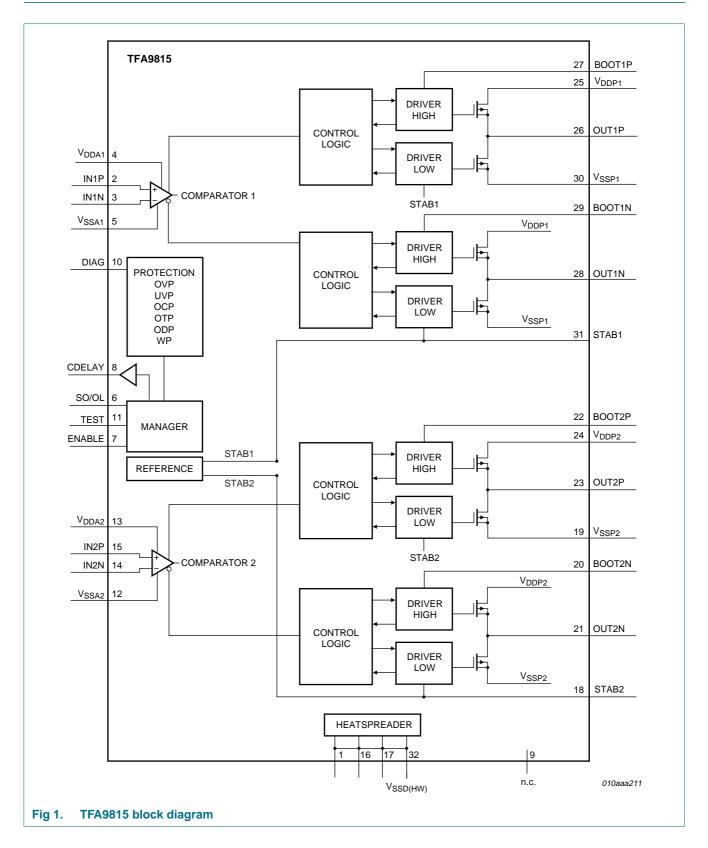
5. Ordering information

Table 2. Ordering information

Type number	Package		
	Name	Description	Version
TFA9815T	SO32	plastic small outline package; 32 leads; body width 7.5 mm	SOT287-1

Audio amplifier 2 x 17 W

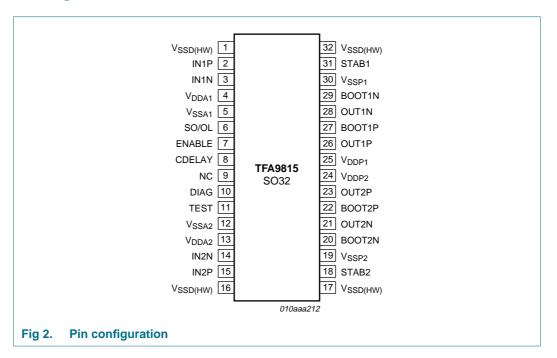
6. Block diagram



Audio amplifier 2 x 17 W

7. Pinning information

7.1 Pinning



The SO32 package has four corner leads. These leads (1, 16, 17 and 32) are internally connected to the die pad and must be connected to $V_{\rm SSA}$. Together with the applied copper area on the PCB these leads determine the ambient temperature, which affects the thermal resistance of the junction.

7.2 Pin description

Table 3. Pin description

Symbol	Pin	Description
$V_{\text{SSD(HW)}}$	1	negative digital supply voltage and handle-wafer connection
IN1P	2	positive input comparator channel 1
IN1N	3	negative input comparator channel 1
V_{DDA1}	4	positive analog supply voltage channel 1
V _{SSA1}	5	negative analog supply voltage channel 1
SO/OL	6	self-oscillating / open-loop configuration enable
ENABLE	7	enable input to switch between Sleep and Operating mode
CDELAY	8	switch on/off timing control
n.c.	9	not connected
DIAG	10	diagnostic output; open-drain
TEST	11	test signal input; for testing purposes only
V _{SSA2}	12	negative analog supply voltage channel 2
V_{DDA2}	13	positive analog supply voltage channel 2
IN2N	14	negative input comparator channel 2

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Table 3. Pin description ... continued

Symbol	Pin	Description
IN2P	15	positive input comparator channel 2
V _{SSD(HW)}	16	negative digital supply voltage and handle-wafer connection
V _{SSD(HW)}	17	negative digital supply voltage and handle-wafer connection
STAB2	18	decoupling of internal 11 V regulator for channel 2 drivers
V _{SSP2}	19	negative power supply voltage channel 2
BOOT2N	20	bootstrap high-side driver negative output channel 2
OUT2N	21	negative output channel 2
BOOT2P	22	bootstrap high-side driver positive output channel 2
OUT2P	23	positive output channel 2
V_{DDP2}	24	positive power supply voltage channel 2
V_{DDP1}	25	positive power supply voltage channel 1
OUT1P	26	positive output channel 1
BOOT1P	27	bootstrap high-side driver positive output channel 1
OUT1N	28	negative output channel 1
BOOT1N	29	bootstrap high-side driver negative output channel 1
V _{SSP1}	30	negative power supply voltage channel 1
STAB1	31	decoupling of internal 11 V regulator for channel 1 drivers
V _{SSD(HW)}	32	negative digital supply voltage and handle-wafer connection

8. Functional description

8.1 General

The TFA9815 is a dual-switching power comparator. It is the main building block for a stereo high-efficiency Class D audio power amplifier system. It contains two full-bridge BTL power stages, drive logic, protection control logic and full differential input comparators and references (see Figure 1). By using this power comparator a compact closed-loop self-oscillating digital amplifier system or open-loop system can be built. A second-order low-pass filter converts the PWM output signal into an analog audio signal across the speaker.

8.2 Interfacing

The pins ENABLE and SO/OL control the Operating mode of the TFA9815. Both the ENABLE and the SO/OL pins are referenced to V_{SSD(HW)}.

When the SO/OL pin is connected to $V_{SSD(HW)}$ the TFA9815 is in self-oscillating configuration: when the SO/OL pin is floating the TFA9815 is in open-loop configuration. Under this latter condition the open-pin voltage is typically 4 V applied internally. The TEST pin needs to be connected to ground in both situations.

Audio amplifier 2 x 17 W

Table 4. SO/OL connections

Interfacing	
SO/OL connected to:	Configuration
V _{SSD(HW)}	Self-oscillating
Open	Open-loop

The device has two modes: Sleep and Operating.

In Sleep mode the TFA9815 is not biased and has a very low supply current. Sleep mode can also be used to quickly mute the device.

When the TFA9815 is set into Operating mode the device is started via the start-up sequence, which provides a pop-free start-up behavior. After start-up the STABn reference voltages are present and the outputs start switching.

Table 5. Start-up

Interfacing	
ENABLE (V)	Mode
ENABLE < 0.8 V	Sleep mode
ENABLE > 3 V	Operating mode

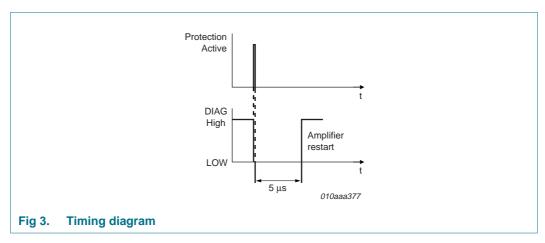
8.3 Input comparators

The input stages have a differential input and are optimized for low noise and offset. This results in maximum flexibility in the application.

Operating in open-loop configuration, no internal voltages are applied to the inputs. The input pins (IN1P, IN1N, IN2P, IN2N) are pulled down to V_{SSA1} and V_{SSA2} level by internal resistors.

8.4 Diagnostic

The DIAG output is an open-drain output. The maximum current is 2 mA. When one of the protections is activated the DIAG output is set LOW. The DIAG output refers to V_{SSD} .



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8.5 Protections

The TFA9815 has the following protections:

- OverTemperature Protection (OTP)
- OverCurrent Protection (OCP)
- OverVoltage Protection (OVP)
- UnderVoltage Protection (UVP)
- OverDissipation Protection (ODP)
- Window Protection (WP)

When either the OTP or the OCP are activated the output power stage is switched off and all the outputs (OUT1N, OUT1P, OUT2N and OUT2P) become floating. The power stage will switch back on after $5~\mu s$ or as soon as the fault condition is removed.

When any other protection is activated (OVP, UVP, ODP, or WP) all the outputs become floating and the device shuts down. The TFA9815 will resume operating after the fault condition has been removed, going through the restart sequence shown in Figure 3. Restarting will typically take 500 ms, depending on the power-supply voltage level.

Overtemperature protection

If the junction temperature (T_j) exceeds a threshold level of about 150 °C the outputs become floating. The device will start switching again after 5 ms and when the temperature is below 150 °C. This thermal limitation is without audible interruptions.

Overcurrent protection

If the output current exceeds the maximum output-current threshold level the outputs become floating. The device will start switching again after 5 μ s. This current limitation is without audible interruptions.

Overvoltage protection

If the supply voltage applied to the TFA9815 exceeds the maximum supply-voltage threshold level the device shuts down. The device will resume operating when the supply is within the operating range, going through the restart sequence.

Undervoltage protection

If the supply voltage applied to the TFA9815 falls below the minimum supply-voltage threshold level the device shuts down. The device will resume operating when the supply is within the operating range, going through the restart sequence.

Overdissipation protection

If the junction temperature (T_j) exceeds 135 °C an internal OverTemperature Warning (OTW) signal is generated. If the overcurrent protection is generated while the OTW is active the device will shut down and resume operating automatically, going through the restart sequence.

Window protection

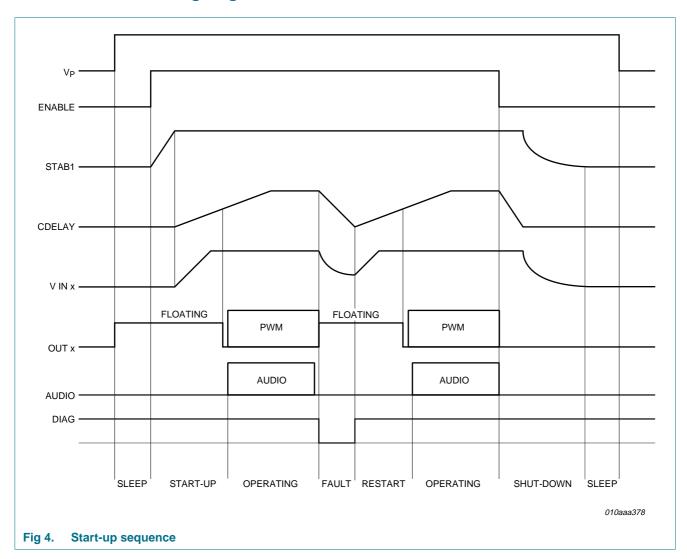
During start-up, if one of the outputs is shorted to V_{SS} or V_{DD} the device will interrupt the start-up sequence and wait until the short is removed. This is an effective measure to protect the device against shorts between the outputs (before the filter) and the ground or supply lines. The WP protects the device against errors made during board assembly.

Audio amplifier 2 x 17 W

Table 6. Overview protections

Protections					
Symbol	Condition	Diag.	Outputs	Recovering	
OTP	T _j > 150 °C	LOW	Floating	Automatic, after 5 μs and T $_{j}$ < 150 $^{\circ}C$	
OCP	I _O > I _{ORM}	LOW	Floating	Automatic, after 5 μs	
OVP	V _P > 20 V	LOW	Floating	Switch-off to restart when $V_P < 20 \text{ V}$	
UVP	V _P < 8 V	LOW	Floating	Switch-off to restart when $V_P > 8 V$	
ODP	T_j > 135 °C and I_O > I_{ORM}	LOW	Floating	Switch-off to restart	
WP	$OUTX > V_{DDA} - 1 V \text{ or } OUTX < V_{SSA} + 1 V$	LOW		Start-up after removing fault condition	

8.6 Timing diagram



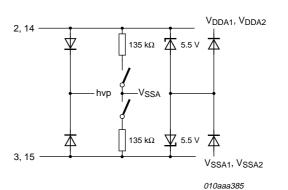
Audio amplifier 2 x 17 W

9. Internal circuitry

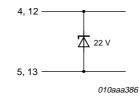
Table 7. Internal circuitry

Pin	Symbol	Equivalent circuit
1	$V_{\text{SSD(HW)}}$	
16	$V_{\text{SSD(HW)}}$	1,16, 17, 32 V _{DDA}
17	$V_{\text{SSD(HW)}}$	$lack \qquad lack \qquad lack \qquad lack \qquad lack \qquad$
32	V _{SSD(HW)}	V _{SSA} 010aaa384

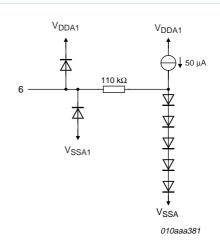
2	IN1P
3	IN1N
14	IN2N
15	IN2P



4	V_{DDA1}
5	V _{SSA1}
12	V_{SSA2}
13	V_{DDA2}

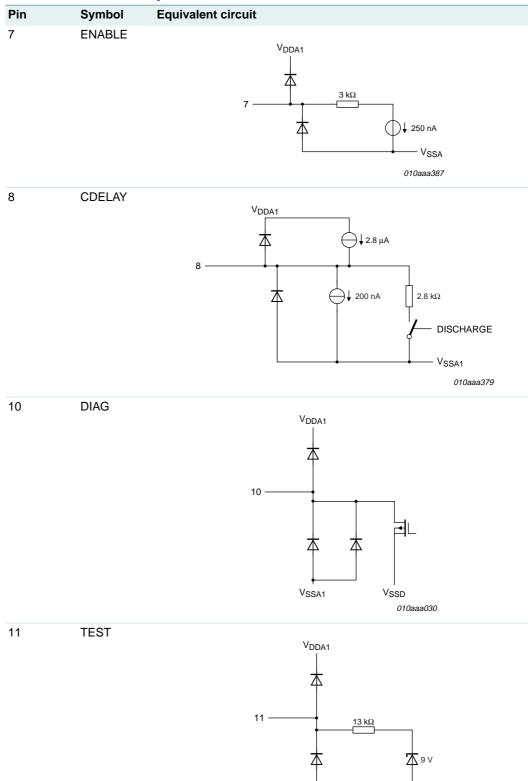


6 SO/OL



Audio amplifier 2 x 17 W

Table 7. Internal circuitry ...continued



V_{SSA1} 010aaa031

Audio amplifier 2 x 17 W

 Table 7.
 Internal circuitry ...continued

Pin	Symbol	Equivalent circuit
18	STAB2	
31	STAB1	V _{DDA1} , V _{DDA2} 50 mA 18, 31 V _{SSD} 010aaa445
19	$V_{\rm SSP2}$	
24	V_{DDP2}	24, 25
25	V_{DDP1}	∑ 23.5 V
30	V_{SSP1}	40.00
		19, 30 ———————————————————————————————————
20	BOOT2N	20, 29 —
29	BOOT1N	12 V OUT2N, OUT1N 010aaa447
21	OUT2N	- V V
23	OUT2P	V _{DDP1} , V _{DDP2}
26	OUT1P	_
28	OUT1N	T
		21, 23, 26, 28 V _{SSP1} , V _{SSP2}
22	BOOT2P	
27	BOOT1P	22, 27 —————————————————————————————————
		OUT2P
		010aaa448

Audio amplifier 2 x 17 W

10. Limiting values

Table 8. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{P}	supply voltage	Asymmetrical		-0.3	+23.1	V
I _{ORM}	repetitive peak output current	-		3	-	Α
Tj	junction temperature	-		-	180	°C
T _{stg}	storage temperature	-		-55	+150	°C
T _{amb}	ambient temperature	-		-40	+85	°C
P _{max}	maximum power dissipation	-		-	5	W
V_x	voltage on pin x	DIAG		$V_{SS}-0.3$	12	V
		IN1P - IN1N		-6	+6	V
		IN2P - IN2N		-6	+6	V
		all other pins		$V_{SS}-0.3$	$V_{DD} + 0.3$	V
V _{esd}	electrostatic discharge	HBM	<u>[1]</u>	-2000	+2000	V
	voltage	MM	[2]	-200	+200	V

^[1] Human-body model (HBM): $R_S = 1500 \Omega$; C = 100 pF; for pins 2, 3, 14, and 15: $V_{esd} = \pm 1500 V$.

11. Thermal characteristics

Table 9. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction	JEDEC test board	<u>[1]</u> -	39	42	K/W
	to ambient	Two-layer application board	<u>[2]</u> _	42	-	K/W
$\Psi_{\text{j-lead}}$	thermal characterization parameter from junction to lead	-	-	-	30	K/W
$\Psi_{ extsf{j-top}}$	thermal characterization parameter from junction to top of package	-	[3] -	-	8	K/W

^[1] Measured in a JEDEC high K-factor test board (standard EIA/JESD 51-7) in free air with natural convection.

^[2] Machine model (MM): R_S = 0 Ω ; C = 200 pF; L = 0.75 μH .

^[2] Two-layer application board (70 mm x 57 mm), 35 μ m copper, FR4 base material in free air with natural convection.

^[3] Strongly depends on where the measurement is taken on the package.

Audio amplifier 2 x 17 W

12. Characteristics

12.1 Static characteristics

Table 10. Characteristics

 V_P = 12 V; T_{amb} = 25 $^{\circ}$ C; f_{osc} = 550 kHz; typical application diagram <u>Figure 12</u>, unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Supply vo	tage						
V _P	supply voltage	single asymmetrical supply $(V_{DD} - V_{SS})$		8	12	20	V
I _P	supply current	Sleep mode		-	110	200	μΑ
I _{q(tot)}	total quiescent current	Operating mode; no load, no snubbers and no filter connected		-	40	50	mA
Series res	stance output power switches						
R_{DSon}	drain-source on-state resistance	T _j = 25 °C		-	150	220	$m\Omega$
Enable inp	ut: pin ENABLE ^[1]						
V_{IL}	LOW-level input voltage	Sleep mode		-	-	8.0	V
V_{IH}	HIGH-level input voltage	Operating mode		3	-	V_{P}	V
I _I	input current	$V_I = 5 V$		-	1	20	μΑ
SO/OL inp	ut: pin SO/OL ^[1]						
V_{IL}	LOW-level input voltage	self-oscillating configuration		0	-	0.4	V
V_{IH}	HIGH-level input voltage	open-loop configuration		3	4	5	V
Stabilizer	output pins STAB1 and STAB2						
V_{O}	output voltage	Operating mode	[1]	10.2	11	11.7	V
Comparate	or full-differential input stage						
$V_{\text{offset(i)(eq)}}$	equivalent input offset voltage	-		-	-	1	mV
$V_{n(i)(eq)}$	equivalent input noise voltage	20 Hz < f < 20 kHz		-	-	15	μV
$V_{i(cm)}$	common-mode input voltage	-		V _{SSA} + 3	-	V _{DDA} – 1	V
I _{IB}	input bias current	-		-	-	1	μΑ
Overtempe	erature protection						
T _{act(th_prot)}	thermal protection activation temperature	-		150	-	180	°C
Overvoltag	ge protection						
V _{th(ovp)}	overvoltage protection threshold voltage	level internal fixed		20.1	21.5	23	V
Undervolta	age protection						
V _{P(uvp)}	undervoltage protection supply voltage	level internal fixed		7	7.5	7.9	V
Overcurre	nt protection						
I _{O(ocp)}	overcurrent protection output current	-	[2]	3	3.5	-	Α

Audio amplifier 2 x 17 W

Table 10. Characteristics ... continued

 V_P = 12 V; T_{amb} = 25 °C; f_{osc} = 550 kHz; typical application diagram Figure 12, unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Window P	rotection (WP)					
Vo	output voltage	HIGH-level	-	$V_{DDA} - 1$	-	V
		LOW-level	-	$V_{SSA} + 1$	-	V

^[1] Measured with respect to V_{SSD}.

12.2 Dynamic characteristics

Table 11. Switching characteristics

 V_{P} = 12 V; T_{amb} = 25 °C; f_{osc} = 550 kHz unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Timing PV	VM output: pins OUT1 and Ol	JT2				
t _r	rise time	$I_O = 0 A$	-	10	-	ns
t _f	fall time	$I_O = 0 A$	-	10	-	ns
$t_{w(min)}$	minimum pulse width	$I_O = 0 A$	-	60	-	ns

12.3 AC characteristics measured in typical application

Table 12. AC characteristics measured in typical application

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$P_{o(RMS)}$	RMS output power	V_P = 15 V; R_L = 8 $\Omega;$ THD = 10 $\%$		15	16	-	W
		V_P = 12 V; R_L = 8 $\Omega;$ THD = 10 $\%$		9	10	-	W
		V_P = 12 V; R_L = 6 $\Omega;$ THD = 10 $\%$		12	13	-	W
		V_P = 12 V; R_L = 4 $\Omega;$ THD = 10 $\%$		17	18	-	W
THD+N	total harmonic distortion-plus-noise	$P_0 = 1 \text{ W}; f_i = 1 \text{ kHz}$	<u>[1]</u>	-	0.05	0.1	%
ηρο	output power efficiency	$P_0 = 2 \times 10 \text{ W}$ at 8 Ω		89	91	-	%
		$P_0 = 2 \times 18 \text{ W at } 4 \Omega$		88	90	-	%
G _{v(cl)}	closed-loop voltage gain	$V_i = 100 \text{ mV (RMS)}; f_i = 1 \text{ kHz}$		18.6	19.3	21	dB
$V_{n(o)}$	output noise voltage	inputs shorted; AES17 brick-wall		-	150	-	μV
S/N	signal-to-noise ratio	$V_0 = 10 \text{ V (RMS)}; G_{V(cl)} = 20 \text{ dB}$		94	96	-	dB
SVRR	supply voltage ripple rejection	Operating mode; f _i = 1 kHz	[2]	34	45	-	dB
α_{cs}	channel separation	$P_0 = 1 W; f_i = 1 kHz$		55	70	-	dB

^[1] THD+N is measured in a bandwidth of 20 Hz to 20 kHz, AES17, brick-wall.

^[2] Current limiting concept: in overcurrent condition no interruption of the audio signal in case of impedance drop.

 $^{[2] \}quad \text{Minimum value determined by R5, R10, R17, R22 equalling +1 \% and R7, R14, R18, R20 equalling -1 \%. }$

Audio amplifier 2 x 17 W

13. Application information

13.1 Output power estimation

For BTL configuration the output power can be estimated using Equation 1:

$$P_{o1\%} = \frac{\left[\left[\frac{R_L}{R_L + 2 \times (R_{DSon} + R_S)}\right] \times V_P\right]^2}{2 \times R_L} \tag{1}$$

Where,

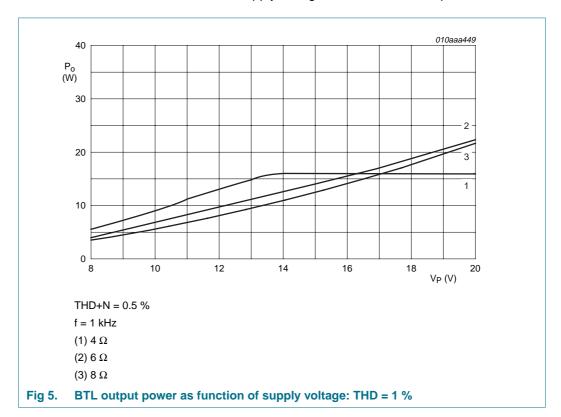
- V_P = supply voltage [V]
- R_L = load impedance [Ω]
- R_{DSon} = on resistance power switch [Ω]
- R_S = series resistance output inductor $[\Omega]$

The output power at 10% THD can be estimated by using Equation 2

 $P = 1.25 \times P$

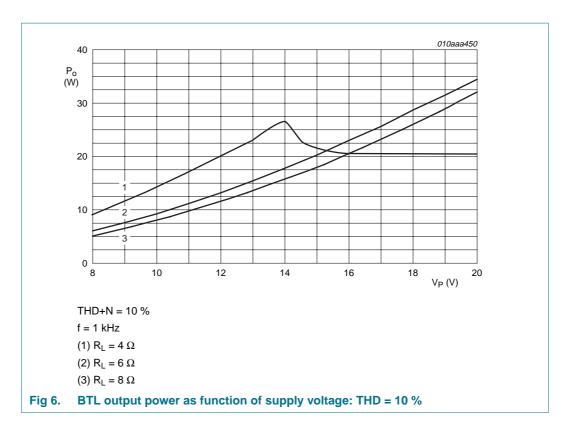
 $P_{o10\%} = 1.25 \times P_{o0.5\%}$

<u>Figure 5</u> and <u>Figure 6</u> below show the estimated output power at THD = 0.5 % and THD = 10 % as a function of the BLT supply voltage for different load impedances.



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13.2 Output current limiting

The maximum peak output current is limited by the level of the overcurrent protection threshold. During normal operation the output current should not exceed this threshold level of 3 A otherwise the OCP will be triggered and the device will stop switching for 5 μ s. The peak output current in BTL can be estimated using the following equation:

$$I_{O}max \le \frac{V_{P}}{R_{L} + 2 \times (R_{DSon} + R_{S})} \le 3A$$

Where:

- V_P = supply voltage [V]
- R_L = load impedance $[\Omega]$
- R_{DSon} = on resistance power switch $[\Omega]$
- R_S = series resistance output inductor $[\Omega]$

13.3 Speaker configuration and impedance

For a flat-frequency response (second-order Butterworth filter) it is necessary to change the low-pass filter components LLC and CLC according to the speaker configuration and impedance. Table 13 shows the practical required values:

Audio amplifier 2 x 17 W

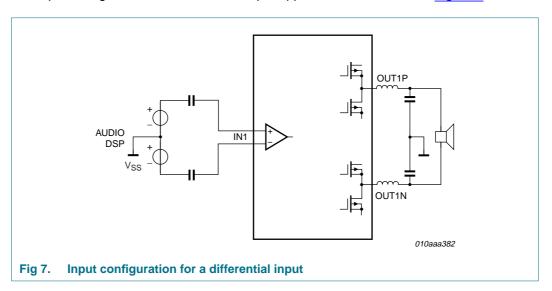
Table 13. Filter component values

Configuration	Impedance (Ω)	LLC (μH)	CLC (nF)
BTL	4	10	1500
	6	15	1000
	8	22	680

13.4 Differential input

For a high common-mode rejection ratio and a maximum of flexibility in the application, the audio inputs of the application are fully differential.

The input configuration for a differential-input application is illustrated in Figure 7.

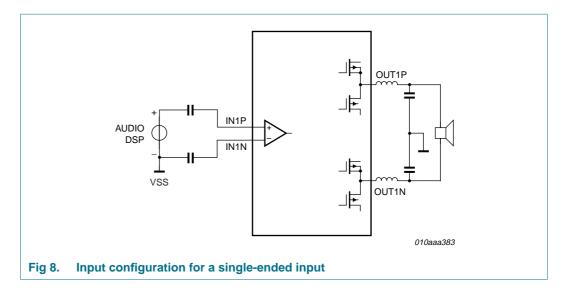


13.5 Single-ended input

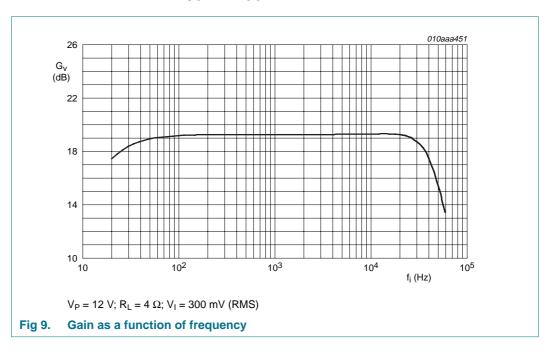
When using an audio source with a single-ended 'out', it is important to connect the IN1N from the application board to the V_{SS} of the audio source (e.g. Audio Digital Signal Processing (Audio DSP)).

The input configuration for a single-ended 'in' application is illustrated in Figure 8.

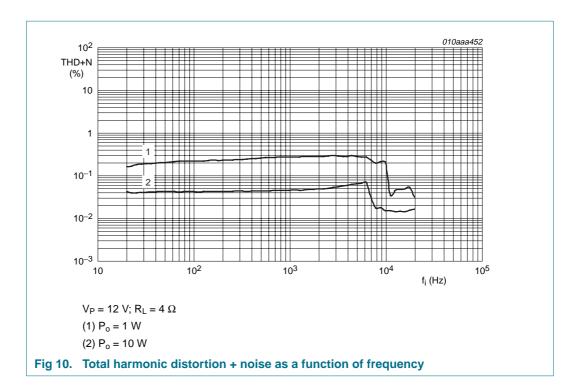
Audio amplifier 2 x 17 W

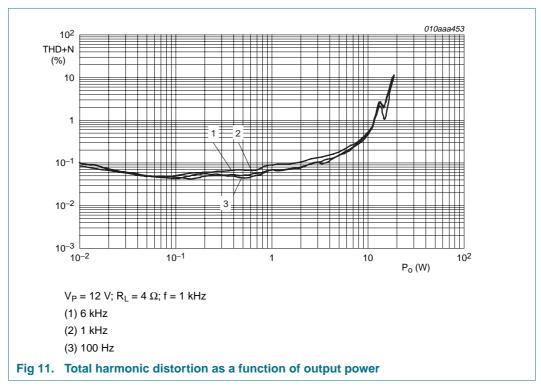


13.6 Curves measured in a typical application



Audio amplifier 2 x 17 W





13.7 Typical application diagram TFA9815

A typical application diagram with the TFA9815 supplied from an asymmetrical supply is shown in Figure 12.

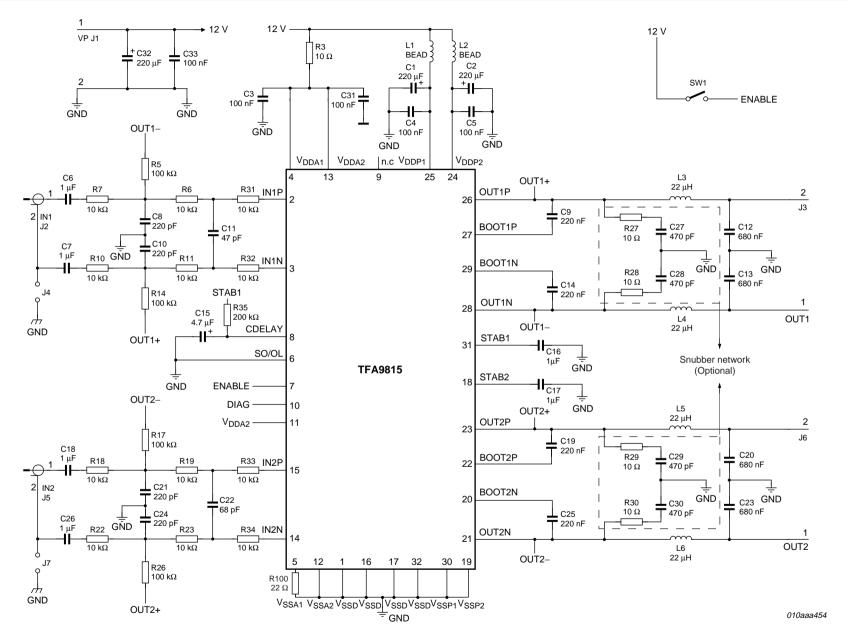


Fig 12. Typical application diagram TFA9815

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Preliminary data sheet

16 December 2008

Audio amplifier 2 x 17 W

13.8 Typical application: bill of materials

Table 14. Typical application: bill of materials

Itom		Poforonco		Footprint
Item	Quantity		Part	Footprint
1	2	C1, C2.	220 mF/35 V	CE09-02R
2	5	C3, C4, C5, C31, C33.	100 nF/50 V	SMD 0805 X7R
3	2	C16, C17.	1 mF/50 V	SMD 1206 X7R
4	4	C6, C7, C18, C26	1 mF/25 V	MKT
5	4	C8, C10, C21, C24.	220 pF/25 V	SMD 0402 NP0
6	4	C9, C14, C19, C25.	220 nF/25 V	SMD 0805 X7R
7	1	C11	47 pF/25 V	SMD 0402 NP0
8	4	C12, C13, C20, C23.	680 nF/25 V	MKT
9	1	C22.	68 pF/25 V	SMD 0402 NP0
10	3	J1, J3, J6.	CON2	2 pins terminal
11	2	J2, J5.	CINCH	CINCH
12	2	J4, J7	Jumper	Closed on demo board only
13	2	L1, L2	BEAD	SMD 1206 Würth Elektronik DC < 0.5 Ω 10 MHz > 80 Ω
14	1	R35	200 kΩ / 0.1 W / 5 %	SMD 0603
15	1	C15	$4.7~\mu F/16~V$	
16	4	L3, L4, L5, L6.	22 μΗ	8RDY TOKO A7040HN-220M,
				11RHBP TOKO A7503CY-220M or Sagami 7311NA-220M
17	5	R3	10 / 0.25 W / 5 %	SMD 1206
18	4	R5, R14, R17, R26.	$\begin{array}{c} 100 \text{ k}\Omega / \\ 0.1 \text{ W} / 1 \text{ \%} \\ \text{for 20 dB} \\ 200 \text{ k} / \\ 0.1 \text{ W} / 1 \text{ \%} \\ \text{for 26 dB} \end{array}$	SMD 0603
19	12	R6, R7, R10, R11, R18, R19, R22, R23, R31, R32, R33, R34.	10 kΩ / 0.1 W / 1 %	SMD 0603
20	1	R100	22 Ω / 5 % / 0.1 W	SMD 0603
21	1	SW1	SC 1X1	Secme 090320901
22	1	U1	TFA9815T	SOT287-1 (SO32) NXP Semiconductors

Remark: The power supply requires at least a 1000 μ F capacitor.

Audio amplifier 2 x 17 W

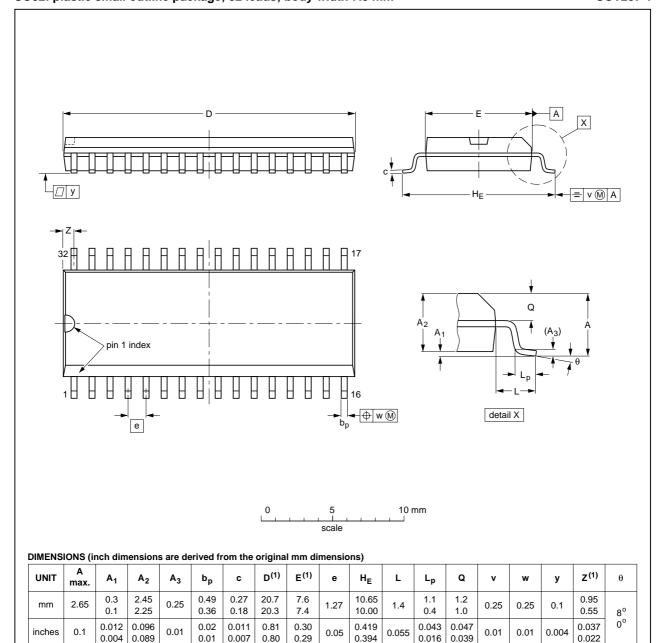
Table 15. Snubber network: bill of materials

Item	Quantity	Reference	Part	Footprint
1	4	C27, C28, C29, C30	470 pF, 25 V	SMD 0805 X7R
2	4	R27, R28, R29, R30	10 / 0.25 W / 5 %	SMD 1206

14. Package outline

SO32: plastic small outline package; 32 leads; body width 7.5 mm

SOT287-1



Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFERENCES			EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA		PROJECTION	1330E DATE
SOT287-1		MO-119				00-08-17 03-02-19

Fig 13. Package outline SOT287-1 (SO32)

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Audio amplifier 2 x 17 W

15. Revision history

Table 16. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
TFA9815_1	20081216	Preliminary data sheet	-	-

Audio amplifier 2 x 17 W

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Audio amplifier 2 x 17 W

18. Contents

1	General description
2	Features
3	Applications
4	Quick reference data 1
5	Ordering information 2
6	Block diagram 3
7	Pinning information 4
7.1	Pinning 4
7.2	Pin description 4
8	Functional description 5
8.1	General 5
8.2	Interfacing 5
8.3	Input comparators
8.4	Diagnostic6
8.5	Protections
8.6	Timing diagram 8
9	Internal circuitry9
10	Limiting values 12
11	Thermal characteristics
12	Characteristics 13
12.1	Static characteristics
12.2	Dynamic characteristics
12.3	AC characteristics measured in typical
	application
13	Application information 15
13.1	Output power estimation
13.2	Output current limiting
13.3	Speaker configuration and impedance 16
13.4	Differential input
13.5	Single-ended input
13.6	Curves measured in a typical application 18
13.7	Typical application diagram TFA9815 19
13.8	Typical application: bill of materials 21
14	Package outline 23
15	Revision history 24
16	Legal information
16.1	Data sheet status 25
16.2	Definitions
16.3	Disclaimers
16.4	Trademarks25
17	Contact information
18	Contents

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